

General Description

The MAX1615/MAX1616 are micropower, SOT23-5 linear regulators that supply always-on, keep-alive power to CMOS RAM and microcontrollers (µCs) in systems with high-voltage batteries. Key features include wide input voltage range, low dropout voltage, and low quiescent supply current.

Despite a miserly 8µA (max) no-load supply current, the MAX1615/MAX1616 have excellent line-transient response and AC power-supply rejection ratio. They provide a clean, fixed 5V or 3.3V output (MAX1615) or an adjustable 1.24V to 28V output (MAX1616), even when subjected to fast supply-voltage changes that occur during the switchover from battery to AC adapter input power. The space-saving SOT23-5 package has excellent thermal characteristics and tolerates up to 571mW of power dissipation. Fault protection is provided by internal foldback current limiting and thermalshutdown circuitry.

Applications

CMOS/RTC Backup Power Microcontroller Power **Notebook Computers Smart-Battery Packs** PDAs and Handy-Terminals Battery-Powered Systems

Features

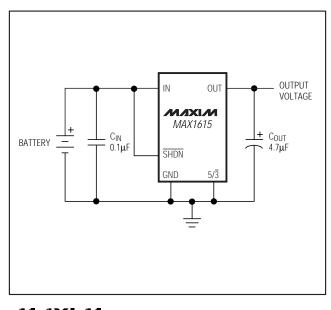
- ♦ 4V to 28V Input Range
- ♦ 8µA (max) Quiescent Supply Current
- ♦ <1µA Shutdown Supply Current
 </p>
- **♦** 3.3V or 5V, Pin-Selectable Output (MAX1615) Adjustable 1.24V to 28V Output (MAX1616)
- **♦ 30mA Output Current**
- **♦ ±2% Initial Output Accuracy**
- **♦ Thermal-Overload Protection**
- **♦ 5-Pin SOT23 Package**
- **♦ Low Cost**

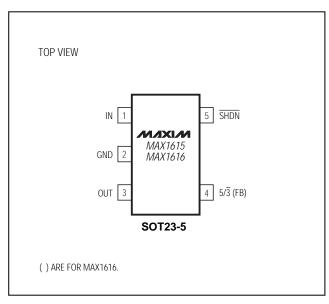
Ordering Information

PART	TEMP. RANGE	PIN- PACKAGE	SOT TOP MARK
MAX1615EUK-T	-40°C to +85°C	5 SOT23-5	ABZD
MAX1616EUK-T	-40°C to +85°C	5 SOT23-5	ABZE

Typical Operating Circuit

Pin Configuration





NIXIN

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

IN to GND0.3V to 30V	Continuous OUT Current
Terminal Voltages to GND	Continuous Power Dissipation ($T_A = +70^{\circ}$ C) (Note 1)
SHDN to GND0.3V to (V _{IN} + 0.3V)	SOT23-5 (derate 7.1mW/°C above +70°C)
5/3 to GND0.3V to (V _{OUT} + 0.3V)	Operating Temperature Range
FB (MAX1616) to GND0.3V to (Vout + 0.3V)	MAX161_EUK-T40°C
OUT to GND0.3V to 30V	Storage Temperature Range65°C t
OUT Short-Circuit to GND30sec	Lead Temperature (soldering, 10sec)

°C above +70°C)......571mW-40°C to +85°C e-65°C to +160°C ng, 10sec)+300°C

Note 1: See Operating Region and Power Dissipation section.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(VIN = 15V, SHDN = VIN, ILOAD = 5µA, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Input Voltage Range	VIN			4		28	V	
Supply Current	livi	SHDN = IN, TA = +25°C			6.2	8	μΑ	
Зирріу Сипепі	IIN	SHDN = IN, V _{IN} = 6V to 28V, T _A = T _{MIN} to T _{MAX}				15		
Minimum Load Current						5	μΑ	
Shutdown Supply Current	IIN	SHDN = GND (shutdown mode)	T _A = +25°C			1.5	μΑ	
	IIIV		T _{MIN} = T _{MIN} to T _{MAX}			3	μΑ	
Dropout Supply Current		Output set to 5V, V _{IN} = 4V	T _A = +25°C		70		μΑ	
		I _{LOAD} = 1mA,	$5/\overline{3} = GND$	3.26	3.33	3.40	- V	
Output Voltage (MAX1615)		$T_A = +25$ °C, $V_{IN} = 6V \text{ to } 28V$	5/3 = OUT	4.95	5.05	5.15		
(Note 3)	T _A =	ILOAD = 5µA to 30mA, TA = TMIN to TMAX, VIN = 6V to 28V	5/3 = GND	3.15		3.48		
			5/3 = OUT	4.75		5.25		
FB Threshold (MAX1616)	Vebt	FB = OUT,	$T_A = +25^{\circ}C$, $I_{LOAD} = 1mA$	1.215	1.240	1.265	V	
(Note 3)	ALRI	$V_{IN} = 6V \text{ to } 28V$	$T_A = T_{MIN}$ to T_{MAX} , $I_{LOAD} = 5\mu A$ to $30mA$	1.18		1.28	'	
FB Input Current (MAX1616)	I _{FB}	V _{FB} = 1.3V		-10	12	30	nA	
Dropout Voltage	ΔVDO	ILOAD = 30mA (Note 4)				350	mV	
Output Current Limit		$V_{IN} = 6V$			100		mA	
OUT Reverse Leakage Current		IN = unconnected, V _{OUT} forced to 5V			70		μΑ	
Capacitive Load		MAX1615		0.16			μE/m Λ	
Requirements (Note 5)		MAX1616					μF/mA	
Start-Up Time Response		Rising edge of IN or \overline{SHDN} to OUT within specification limits, R _L = 500Ω , C _{OUT} = 6.8μ F, V _{OUT} set to 5V				1	ms	
Start-Up Overshoot	Vosh	$R_L = 500\Omega$, $C_{OUT} = 10\mu F$ within 90% of nominal output voltage			0.5		%V _{OUT}	

ELECTRICAL CHARACTERISTICS (continued)

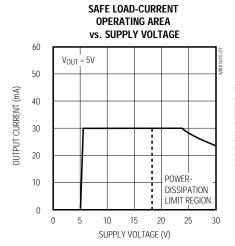
 $(V_{IN} = 15V, \overline{SHDN} = V_{IN}, I_{LOAD} = 5\mu A, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}\text{C.})$ (Note 2)

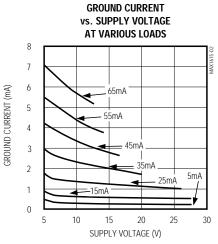
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SHDN Input Threshold	VIL				0.25	\/
Voltage	VIH		1.4			\ \ \
SHDN Input Current		V SHDN = 0V or 15V	-1		1	μΑ
Thermal-Shutdown Temperature	TSHDN	V SHDN = 0V or 15V, hysteresis = +20°C		150		°C

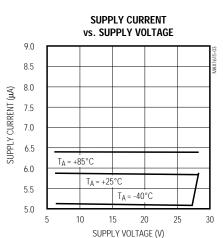
- **Note 2:** Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed through correlation using standard quality-control (SQC) methods.
- Note 3: Pulse tested at V_{IN} = 28V, I_{LOAD} = 30mA to avoid exceeding package power-dissipation limits.
- Note 4: Guaranteed by design. Tested with VouT set to 5V. Dropout voltage is tested by reducing the input voltage until VouT drops to 100mV below its nominal value, measured with V_{IN} starting 2V above VouT.
- Note 5: Use at least 1μF minimum for light loads. Add 0.125μF/mA (0.2μF/mA for the MAX1616) for loads greater than 100μA, not production tested. See *Capacitor Selection* in the *Applications Information* section.

_Typical Operating Characteristics

(V_{OUT} set to 5V, $T_A = +25$ °C, unless otherwise noted.)

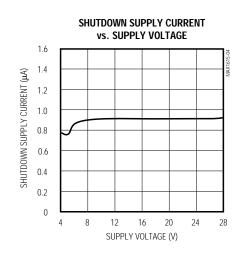


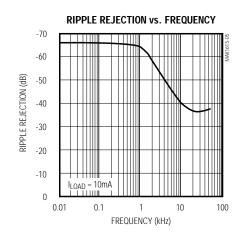


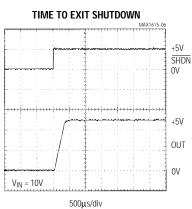


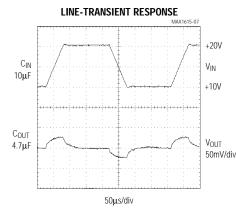
Typical Operating Characteristics (continued)

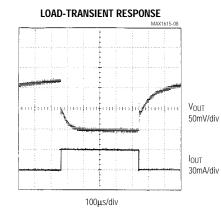
(V_{OUT} set to 5V, $T_A = +25$ °C, unless otherwise noted.)

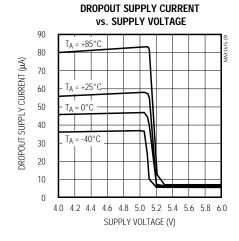


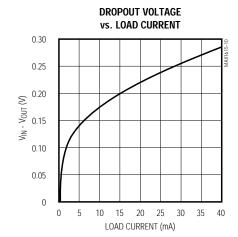












Pin Description

P	PIN	NAME	FUNCTION	
MAX1615	MAX1616	INAIVIE	FUNCTION	
1	1	IN	Positive Input Voltage. Connect to a +4V to +28V supply.	
2	2	GND	Ground	
3	3	OUT	Regulator Output	
4	_	5/3	Preset Output Voltage Select. Connect to GND for 3.3V output or to OUT for 5.0V output.	
_	4	FB	Feedback Input. Regulates to 1.24V nominally.	
5	5	SHDN	Shutdown, active low input. Connect to IN for automatic start up.	

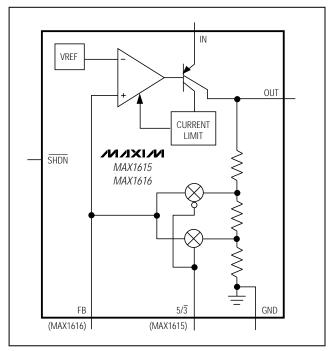


Figure 1. Functional Diagram

Detailed Description

The MAX1615/MAX1616 low-quiescent-current linear regulators are designed primarily for high input voltage applications. The MAX1615 supplies a preselected 3.3V or 5.0V output for loads up to 30mA. The MAX1616 provides an adjustable voltage from 1.24V to 28V. The maximum output current is a function of the package's maximum power dissipation for a given temperature. A 5µA load is required to maintain output regulation.

The MAX1615's output voltage is fed back through an internal resistor voltage divider connected to OUT. Set the output voltage to either 3.3V or 5.0V with the $5/\overline{3}$ pin.

Select the 5V output by connecting $5/\overline{3}$ to OUT, or the 3.3V output by connecting $5/\overline{3}$ to GND.

The MAX1616 uses external feedback, allowing the output voltage to be set by external resistors (see *Setting the MAX1616 Output Voltage* section). The typical FB threshold is at 1.24V.

Shutdown

The device enters shutdown mode when \overline{SHDN} is low. In shutdown mode, the pass transistor, control circuit, reference, and all biases turn off, reducing the supply current to below 1µA. Connect \overline{SHDN} to IN for automatic start-up.

Current Limit

Output current is limited to 100mA (typical). The current limit exceeds the 30mA (max) safe operating limit. The output can be shorted to ground for 30 seconds without damaging the part.

Thermal-Overload Protection

When the junction temperature exceeds $T_J = +150\,^{\circ}\text{C}$, the thermal sensor sends a signal to the shutdown logic, turning off the pass transistor and allowing the IC to cool. The thermal sensor turns the pass transistor on again after the IC's junction temperature cools by $+20\,^{\circ}\text{C}$ (typical), resulting in a pulsating output during continuous thermal-overload conditions.

Operating Region and Power Dissipation

Maximum power dissipation depends on the thermal resistance of the case and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow. The device's power dissipa-

tion is P = IOUT (VIN - VOUT). The power dissipation at $+70^{\circ}C$ ambient is 571mW (see *Absolute Maximum Ratings*). The thermal resistance junction-to-case of the SOT23-5 package is 81°C/W, and the maximum safe junction temperature is $+150^{\circ}C$.

The GND pin performs the dual function of providing an electrical connection to ground and channeling heat away. Connect GND to ground using a large pad or ground plane.

Applications Information

Setting the MAX1616 Output Voltage

Set the MAX1616's output voltage with two resistors, R1 and R2 (Figure 2). Choose $R2 = 250k\Omega$ to maintain a 5µA minimum load and calculate R1 using the following equation:

$$R1 = R2 \left(\frac{V_{OUT}}{V_{FBT}} - 1 \right)$$

where $V_{FBT} = 1.24V$ (typical).

Capacitor Selection

Use a 0.1µF minimum capacitor on the input. Higher values will improve line-transient response.

Use 1µF minimum on the output, or 4.7µF for the full 30mA load current (6.8µF, MAX1616). Otherwise, use 1µF plus 0.125µF/mA (0.2µF/µA, MAX1616). For output voltages less than 3.3V, use 15µF instead of 6.8µF. The output capacitor's effective series resistance (ESR) must be less than 1 Ω for stable operation.

Output Voltage Noise

The MAX1615/MAX1616 typically exhibit 5mVp-p of noise during normal operation. This is negligible in most applications. In applications that include analog-to-digital converters (ADCs) of more than 12 bits, consider the ADC's power-supply-rejection specifications.

Transient Response

The Typical Operating Characteristics show the MAX1615/MAX1616's load-transient response. Two of the output response's components can be observed on the load-transient graph: a DC shift from the output impedance due to the different load currents, and the transient response. Typical step changes in the load current from 10mA to 20mA produce 50mV transients. Increasing the output capacitor's value attenuates transient spikes.

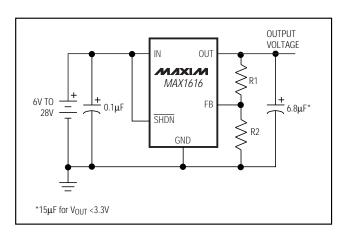


Figure 2. MAX1616 Typical Application Circuit

Table 1. Surface-Mount Capacitor Manufacturers

TYPE	MANUFACTURER	CAPACITOR		
	AVX	TPS series		
Electrolytic	Matsuo	267 series		
	Sprague	593D, 595 series		
Ceramic	AVX	X7R		
Ceramic	Matsuo	X7R		

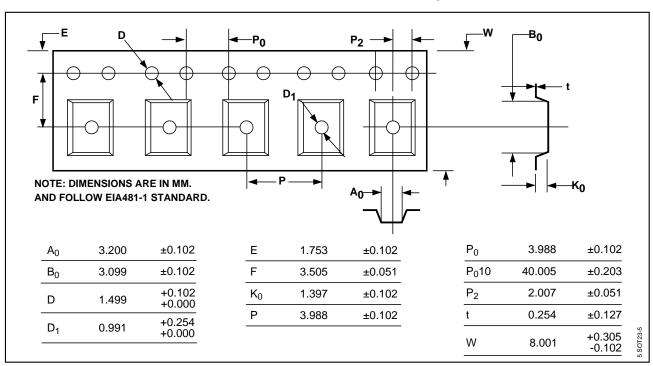
Table 2. Component Suppliers

SUPPLIER	PHONE	FAX
AVX	(803) 946-0690	(803) 626-3123
Matsuo	(714) 969-2491	(714) 960-6492
Sprague	(603) 224-1961	(603) 224-1430

Chip Information

TRANSISTOR COUNT: 386

Tape-and-Reel Information



Package Information 0.20 ″∀″ SYMBOL MIN MAX Α 0.90 1.45 DATUM Α1 0.00 0.15 1.30 0.90 Α2 0.50 0.35 0.08 0.20 D 2.80 3.00 2.60 1.50 3.00 1.75 E: 0.35 0.55 Ģ 0.95 REF Qe 1.90 REF e1 0° NOTE: Œ 1. ALL DIMENSIONS ARE IN MILLIMETERS.

A FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE. 3. PACKAGE DUTLINE EXCLUSIVE OF MOLD FLASH & METAL 4. PACKAGE DUTLINE INCLUSIVE OF SOLDER PLATING. A1-

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PACKAGE DUTLINE, SDT23,

21-0057

В